RTE7701412CBF484T000R
Exchange Adapter for Connecting RH850/D1x Series in 484-pin 1.0-mm-pitch BGA

1. Outline
The RTE7701412CBF484T000R is an exchange adapter (EA) for connecting an RTE7701412EPA00000R or RTE7701460EPA00000R emulator pod (subsequently referred to as the pod) for the RH850/D1x to pad patterns for a 484-pin 1.0-mm-pitch BGA (PRBG0484FF-A).

2. Package Components
Check to see if the RTE7701412CBF484T000R package has all the following contents with reference to Contents of the Package included in the package after purchasing this product.

(1) RTE7701412CBF484T000R exchange adapter 1 pc.
(2) Table of Toxic and Hazardous Substance and Elements 1 sh.

3. Specifications

<table>
<thead>
<tr>
<th>Table 1 Specifications</th>
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<tbody>
<tr>
<td>Applicable package</td>
</tr>
<tr>
<td>(484-pin 1.0-mm-pitch BGA)</td>
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<tr>
<td>Insertion/removal</td>
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<tr>
<td>Iterations of connector</td>
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</tbody>
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4. Usage (See Figure 2)
The RTE7701412CBF484T000R can be used for debugging and on-board evaluation in common by mounting the TC on the target system.

(1) For debugging
Mount the TC on the pad pattern for the MCU on the target system board. In addition, connect the RTE7701412CBF484T000R to the pod, and then attach the RTE7701412CBF484T000R above the TC. The height of the socket is adjustable by inserting the SA1 or SA2 between the TC and RTE7701412CBF484T000R if this is desired.

Before using the SA1 or SA2, be sure to read the precautions on page 3.

(2) For on-board evaluation
The TC on the user system is used to attach the MA after it has been fitted with an MCU that has flash ROM or a one-time PROM.

SA1: Space adapter (sold separately, product of Tokyo Eletech Corporation)
Model Name: CSSOCKET484Z2627RE03
SA2: Space adapter (sold separately, product of Tokyo Eletech Corporation)
Model Name: CSSOCKET484Z2627RE04
TC: Target connector (sold separately, product of Tokyo Eletech Corporation)
Model name: BSSOCKET484Z2627RE21N
MA: Mounting adapter (sold separately, product of Tokyo Eletech Corporation)
Model name: LSPACK484Z2627RE01

Figure 1 External View of the RTE7701412CBF484T000R

Figure 2 Usage of the RTE7701412CBF484T000R
5. Connection Procedure (See Figure 3)

The procedure for connecting the RTE7701412CBF484T000R is shown below.

1. Mount the TC on the user system.
2. Attach the RTE7701412CBF484T000R to the pod.
3. Attach the RTE7701412CBF484T000R to the TC.

Confirm that there are neither cracks nor bends on the contact pins of the RTE7701412CBF484T000R at the time it is attached.

- **Adjusting the height of the socket**
  The height of the socket is adjustable by inserting an SA1 or SA2 between the TC and the RTE7701412CBF484T000R. For more information on the SA1 and SA2, contact Tokyo Eletech Corporation.

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6. Drawing of the Socket Assembly, Drawing with Dimensions, and Pad Pattern for Reference

- **Figure 3** Procedure for Connecting the RTE7701412CBF484T000R

- **Figure 4** Drawing of the Socket Assembly (for RTE7701412EPA00000R)

*SA1: Space adapter (sold separately, product of Tokyo Eletech Corporation)*

Model Name: CSSOCKET484Z2627RE03

*SA2: Space adapter (sold separately, product of Tokyo Eletech Corporation)*

Model Name: CSSOCKET484Z2627RE04

*TC: Target connector (sold separately, product of Tokyo Eletech Corporation)*

Model name: BSSOCKET484Z2627RE21N*
Figure 5  Drawing of the Socket Assembly (for RTE7701460EPA00000R)

*This dimension is increased by 3.3 mm if CSSOCKET484Z2627RE03 or CSSOCKET484Z2627RE04 is used to adjust the height of the socket.

Unit [mm]
### 7. Precautions and WEEE Directive

#### CAUTION

If the requirements shown in the "CAUTION" sentences are ignored, the equipment may cause personal injury or damage to the products.

<table>
<thead>
<tr>
<th>CAUTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>Cautions to be Taken for This Product:</td>
</tr>
<tr>
<td>1. Inquiries regarding the combination of CSSOCKET484Z2627RE03 and CSSOCKET484Z2627RE04 used for adjusting the height of the assembly, please send an email to the address below.</td>
</tr>
<tr>
<td>Tokyo Eletech Corporation <a href="http://www.tetc.co.jp/e_index.htm">http://www.tetc.co.jp/e_index.htm</a></td>
</tr>
</tbody>
</table>

#### IMPORTANT

<table>
<thead>
<tr>
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<tr>
<td>Note on This Product:</td>
</tr>
<tr>
<td>1. This product is not reparable.</td>
</tr>
<tr>
<td>2. Inquiries regarding the purchase of BSSOCKET484Z2627RE21N, CSSOCKET484Z2627RE03, CSSOCKET484Z2627RE04, LSPACK484Z2627RE01, please send an email to the address below.</td>
</tr>
<tr>
<td>Tokyo Eletech Corporation <a href="http://www.tetc.co.jp/e_index.htm">http://www.tetc.co.jp/e_index.htm</a></td>
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</tbody>
</table>

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